

Low Voltage and High Speed Dual SPDT Analog Switch with True Isolation

Descriptions

The RLCS4717 is a dual SPDT low on-resistance analog switch. It can operate from a single 1.5V to 5.5V power supply. The device offers low ON-state resistance and excellent ON-state resistance matching with break-before-make feature, to prevent signal distortion during the transferring of a signal from one channel to another. The device is capable of true isolation. Even when COMx overrides VCC, very little current will flow back to the supply.

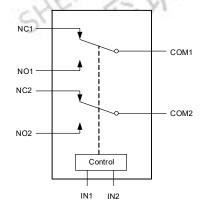
Features

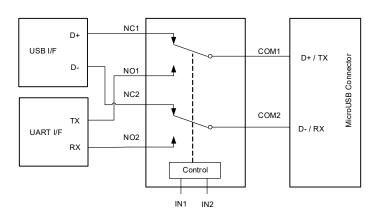
- \triangleright Low On-resistance, Ron=1.5Ω when COMX=5V
- ➤ 1.8V Logic Compatible Control Pin
- COMx Overrides VCC to Achieve True Isolation Even When Supply Is Dead
- ➤ High Off-Isolation: -100dB @ 100KHz
- ➤ Low Channel-to-Channel Crosstalk: -97dB @ 100KHz
- High Bandwidth (-3dB @700MHz) Suitable For USB2.0 High-Speed Routing
- ➤ Low Quiescent Current (<2uA) With Very Wide Supply Range (1.5V ~ 5.5V)

Applications

- Audio
- Video
- ➤ UART
- USB2.0 Signal and Supply Routing
- Cell phones
- TWS headset

Typical Application

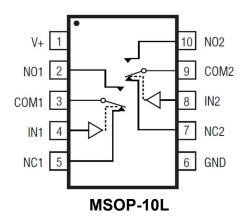




Configured as USB2.0 Mux



Functions and Pin Configuration



Pin Descriptions

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Pin Number	Symbol	Descriptions
1	VCC	Single Power Supply
2,10	NO _X	Analog/Digital Signal Ports (Normally open)
3,9	COM _X	Common Signal Ports
5,7	NC _X	Analog/Digital Signal Ports (Normally closed)
6	GND	Ground
4,8	IN _X	Logic Input Control

Function Descriptions

Logic Input(IN _X)	Function
0	NC1=COM1 and NC2=COM2
1 545	NO1=COM1 and NO2=COM2

Note: X= 1 or 2

Order Information

Package		Part Number	Quantity per Reel		
MSOP -10L	Tape and Reel	RLCS4717MS10/R6	3,000PCS		



Absolute Maximum Ratings (1)

Parameter	Symbol	Value	Unit
Supply Voltage	V_{CC}	-0.3 ~ 6.5	V
Control Input Voltage	V_{IN}	-0.3 ~ 6.5	V
Continuous Current Through NO, NC, COM		±100	mA
Peak Current Through NO, NC, COM (pulsed at 1ms 50%		+200	mA
duty cycle)		±200	IIIA
Storage Temperature Range	T_{STG}	-55 ~ 150	°C
Junction Temperature under Bias	T_J	150	°C
Lead Temperature (Soldering, 10 seconds)	T_L	260	°C
Power Dissipation	P_D	250	mW

Recommend operating ratings (2)

Parameter	Symbol	Value	Unit
Supply Voltage Operating	V _{CC}	1.5 ~ 5.5	V
Control Input Voltage	V _{IN}	-0.3 ~ 5.5	V
Input Signal Voltage	V _{COM}	-0.3 ~ 5.5	V
Operating Temperature	T _A	-40 ~ 85	°C
Thermal Resistance	$R_{\theta JA}$	360	°C/W

Note:

1. "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied.



DC Electronics Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input logic high lovel	V	VCC: 3.3 ~ 5.5V	1.6			V
Input logic high level	V _{IH}	VCC: 1.5 ~ 3.3V	1.4			٧
Input logic low lovel	V.	VCC: 3.3 ~ 5.5V			0.6	٧
Input logic low level	VIL	VCC: 1.5 ~ 3.3V			0.4	٧
Supply quiescent current	Icc	I _{COM} =0, V _{IN} =0 or V _{IN} =VCC			1.0	uA
Increase in L., per input	1	I _{COM} =0, VCC=4.5V			1.0	
Increase in Icc per input	Ісст	V _{IN} >1.8 or V _{IN} <0.5			1.0	uA
Off state leakage from	Ісомх	V _{COM} = 5.5V , V _{NC(or NO)} = 0V		±20	±40	nA
COMx to NCx (or NOx)	_	. , ,			- 25	\
	R _{ON1}	V _{COM} =0 ~ 0.5V, I _{COM} =30mA		3.0	3.5	Ω
	R _{ON2}	V_{COM} =0.5 ~ 2.0V,		3.6	3.9	Ω
		I _{COM} =30mA	100	C	0.0	32
On-Resistance	R _{ON3}	$V_{COM}=2.0 \sim 4.0 V$,	111	2.5	3.5	Ω
		I _{COM} =30mA	3/4	2.5	3.3	32
	R _{ON4}	V_{COM} =4.0 ~ 5.5V,	1	1.5	1.8	Ω
		I _{COM} =30mA	17			
	R _{FLAT1}	V _{COM} =0 ~ 0.5V, I _{COM} =30mA	137	0.7		Ω
	В	V_{COM} =0.5 ~ 2.0V,	3.	0.5)
	R _{FLAT2}	I _{COM} =30mA				Ω
On-Resistance Flatness	n (c)	V _{COM} =2.0 ~ 4.0V, I _{COM} =30mA		1.6		Ω
	R _{FLAT3}					
	R _{FLAT4}	V _{COM} =4.0 ~ 5.5V,		0.0		
0		I _{сом} =30mA		0.3		Ω
On-Resistance Matching Between Channels	Δ Ron	V _{СОМ} =0~5.5V, I _{СОМ} =30mA,		0.1	0.2	Ω

AC Electronics Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

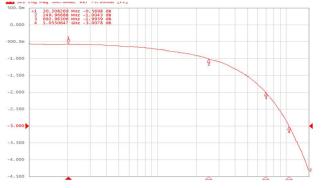
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Turn-On Time	Ton	V_{COM} =1.5V, C _L =35pF, R _L =50 Ω		200		ns
Turn-Off Time	Toff	V_{COM} =1.5V, C_L =35pF, R_L =50 Ω		200		ns
Break-Before-Make time	T _{BBM}	V_{COM} =1.5V, C_L =35pF, R_L =50 Ω		500		ns
-3dB Bandwidth BW		R _L =50Ω, C _L =0pF		850		MHz
Off in alleting	OIRR	F=1KHz, R _L =50Ω		-81		dB
Off isolation		F=10KHz, R_L =50 Ω		-80		dB
Charatally	Vtalle	F=1KHz, R _L =50Ω		-83		dB
Crosstalk	Xtalk	F=10KHz, R_L =50 Ω		-82		dB
Total Harmonia Distortion	TUD	F=20Hz to 20KHz	Ω,			٩D
Total Harmonic Distortion	THD	V _{COM} =600mVp-p @R _L =32Ω,				dB

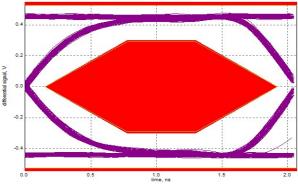
Capacitance (Ta=25°C, VCC=3.3V, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Off capacitance	C _{OFF}	F=100KHz		5		pF
On capacitance	Con	F=100KHz		7		pF



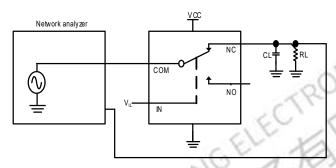
Typical Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)



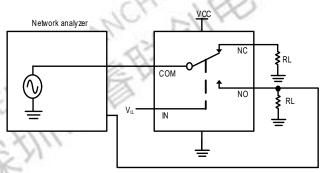


Eye Diagram (480Mbps)

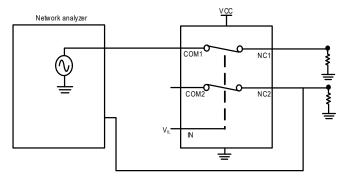
Bandwidth



Bandwidth



Off isolation

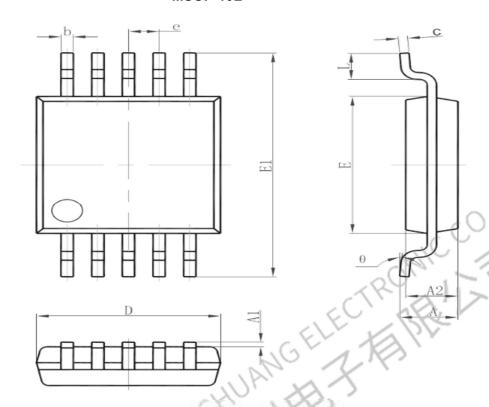


Crosstalk



Package Outline Dimensions

MSOP-10L



Cymbol	Dimension in Millimeters			
Symbol	Min.	Max.		
Α	0.820	1.100		
A1	0.020	0.150		
A2	0.750	0.950		
b	0.180	0.280		
С	0.090	0.230		
D	2.900	3.100		
е	0.50	O(BSC)		
E	2.900	3.100		
E1	4.750	5.050		
L	0.400	0.800		
θ	0°	6°		



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